

Amendments to the Claims

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Original) A liquid crystal display device comprising:
 - a substrate;
 - a first conductive layer on the substrate;
 - a first insulating layer on the first conductive layer;
 - a second conductive layer on the first insulating layer;
 - a third conductive layer on the second conductive layer;
 - a second insulating layer on the third conductive layer, the second insulating layer having a hole exposing a portion of the third conductive layer;
 - a fourth conductive layer on the second insulating layer and electrically contacting the third conductive layer; and
 - a fifth conductive layer between the third conductive layer and the fourth conductive layer.
2. (Original) The liquid crystal display device according to claim 1, wherein the first conductive layer includes a metal.
3. (Original) The liquid crystal display device according to claim 2, wherein the metal includes Al.
4. (Original) The liquid crystal display device according to claim 1, wherein the second conductive layer includes a semiconductor.

5. (Original) The liquid crystal display device according to claim 4, wherein the third conductive layer has first and second parts spaced from each other and the semiconductor is etched at between the first and second parts of the third conductive layer.

6. (Original) The liquid crystal display device according to claim 1, wherein the third conductive layer includes a metal.

7. (Original) The liquid crystal display device according to claim 1, wherein the fourth conductive layer includes a transparent electrode.

8. (Original) The liquid crystal display device according to claim 1, wherein the fifth conductive layer includes a metal.

9. (Original) The liquid crystal display device according to claim 8, wherein the metal is selected from the group consisting of Mo, Ni, Cr, Cu, Ag and Pb.

10. (Currently Amended) The liquid crystal display device according to claim 1, further comprising a ~~second~~ semiconductor layer between the first insulating layer and the second conductive layer.

11-26. (Withdrawn)